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DS38EP100 1 to 5 Gbps, Power-Saver Equalizer for Backplanes and Cables

General Description

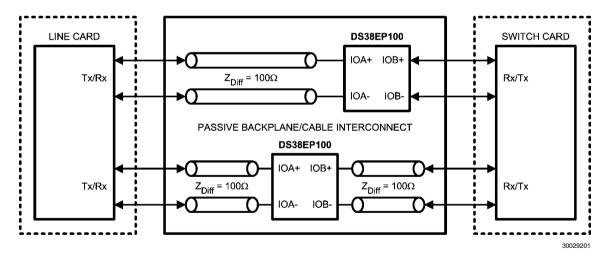
National's Power-saver equalizer compensates for transmission medium losses and minimizes medium-induced deterministic jitter. Performance is guaranteed over the full range of 1 to 5 Gbps. The DS38EP100 requires no power to operate. The equalizer operates anywhere in the data path to minimize media-induced deterministic jitter in both FR4 and cable applications. Symmetric I/O structures support full duplex or half duplex applications. Linear compensation is provided independent of line coding or protocol. The device is ideal for both bi-level and multi-level signaling.

The equalizer is available in a 6 pin leadless LLP package with a space saving 2.2 mm X 2.5 mm footprint. This tiny package provides maximum flexibility in placement and routing of the Power-saver equalizer.

Features

- 1 to 5 Gbps Operation
- No Power or Ground Required
- Equalization effective anywhere in data path
- Equalizes CML, LV-PECL, LVDS signals
- Symmetric I/O structures provide equal boost for bidirectional operation
- 7 dB Maximum Boost
- Code independent, 8b/10b or Scrambled
- Supports both bi-level and multi-level signaling
- Extends reach over backplanes and cables
- Compatible with PCI-Express Gen1 and Gen2
- Compatible with XAUI
- Operates in series with existing active Equalizer
- Easy to handle 6 pin LLP

Simplified Application Diagram



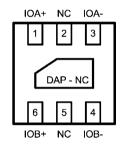
Note: The DS38EP100 provides the flexibility of passing the data from either side of the device. It can be placed anywhere in the data path...

Pin Descriptions

| Pin Name | Pin Number | I/O, Type | Description | | | | |
|-----------------------------|------------|-----------|-------------------|--|--|--|--|
| High Speed Differential I/O | | | | | | | |
| IOA- | 3 | I/O | Symmetric | | | | |
| IOA+ | 1 | | differential I/O. | | | | |
| IOB- | 4 | I/O | Symmetric | | | | |
| IOB+ | 6 | | differential I/O. | | | | |
| NC | 2, 5 | N/A | Reserved. | | | | |
| Exposed | DAP | | Do not connect. | | | | |
| Pad | | | | | | | |

Note: I = Input / O = Output

Pin Diagram



Bottom View shown 2.2mm x 2.5mm 6-Pin LLP Package Order number DS38EP100

1.3kV

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

INPUT/OUTPUT

(IOA+ and IOB+) or (IOA- and IOB-) +2V (IOA+ and IOA-) or (IOB+ and IOB-) +4V (IOA+ and IOB-) or (IOA- and IOB+) +4V Junction Temperature +150°C Storage Temperature -65°C to +150°C Lead Temperature Soldering, 4 sec +260°C **ESD** Rating HBM, $1.5 \text{ k}\Omega$, 100 pF

Recommended Operating Conditions

Min Typ Units Max Operating Temperature -40 25 +85 °C Bit Rate 5 Gbps

Electrical Characteristics (Note 6) Over recommended operating conditions unless other specified. All parameters are guaranteed by test, statistical analysis or design.

| Symbol | Parameter | Conditions | Min | Typ (Note 2) | Max | Units |
|-----------------|--|---|--------------|--------------------|------------|-------|
| V _{IN} | Input voltage swing | See (Note 3) | | 1000 | 3600 | mVp-p |
| | Equalization | 2.5 GHz relative to 100MHz | | 6 | | dB |
| R_Ll | Differential input return loss | 100 MHz – 2.5 GHz, with fixture's effect de- embedded | | 15 | | dB |
| R_{LO} | Differential output return loss | 100 MHz – 2.5 GHz, with fixture's effect de- embedded. IOA+,or IOB+ = static high. | | 15 | | dB |
| R_{IN} | Input Impedance | Differential across IOA+ and IOA-, or IOB+ and IOB-, ZLOAD = 100Ω | | 100 | | Ω |
| R _o | Output Impedance | Differential across IOA+ and IOA-, or IOB+ and IOB-, ZSOURCE = 100Ω | | 100 | | Ω |
| | Through Response | Relative to ideal load, see Figure 2 for setup | See Figure 3 | and <i>Table 1</i> | for limits | |
| R1 | Resistance IOA+ to IOA- and IOB+ to IOB- | No load, high impedance on all ports | | 150 | | Ω |
| R2 | Resistance IOA+ to IOB+ and IOA- to IOB- | No load, high impedance on all ports | | 50 | | Ω |
| R3 | Resistance IOA+ to IOB- and IOA- to IOB+ | No load, high impedance on all ports | | 150 | | Ω |
| | DC Gain (IOA/IOB or IOB/IOA) | ZLOAD = 100Ω | | 0.4 | | |
| DJ1 | Residual deterministic jitter | 2.5 Gbps, 40 in of 6mil microstrip FR4 | | 0.1 | | 1.11 |
| | | See (Note 4) | | 0.1 | | Ulp-p |
| DJ2 | Residual deterministic jitter | 3.125 Gbps, 40 in of 6mil microstrip FR4 | 0.1 | | 0.15 | Ulp-p |
| | | See (Notes 4, 5) | | | | |
| DJ3 | Residual deterministic | 3.8 Gbps, 40 in of 6mil microstrip FR4 | | 0.1 | 0.15 | Ulp-p |
| | jitter | See (Notes 4, 5) | | | | |
| DJ4 | Residual deterministic jitter | 5 Gbps, 30 in of 6mil microstrip FR4 | | 0.1 | | Ulp-p |
| | | See (Note 4) | | | | |

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the Recommended Operating Conditions is not implied. The Recommended Operating Conditions at which the device is functional and the device should not be operated beyond such conditions.

Note 2: Typical values represent most likely parametric norms, TA = +25 degC, and at the Recommended Operating Conditions at the time of product characterization and are not guaranteed.

Note 3: Differential signal to Equalizer, measured at the input to a transmission line, see point A of *Figure 1*. The transmission line is $Z_0 = 100\Omega$, 6-mil, microstrip in FR4 material.

Note 4: Deterministic jitter is measured at the differential outputs (point C of Figure 1), minus the deterministic jitter before the test channel (point A of Figure 1). Test pattern: PRBS- 7.

Note 5: Specification is guaranteed by characterization and is not tested in production.

Note 6: The Electrical Characteristics tables list guaranteed specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not guaranteed.

Test Setup Diagrams

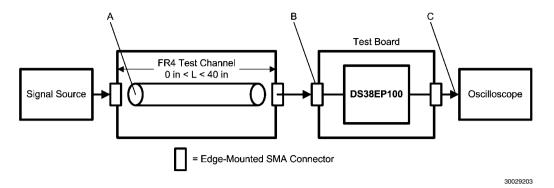


FIGURE 1. Transient Test Setup Diagram

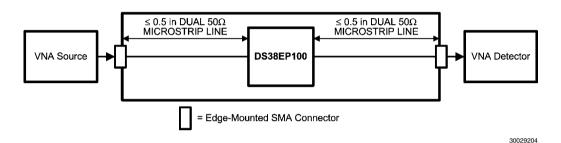


FIGURE 2. Frequency Response Test Circuit

Typical Equalizer Transfer Function

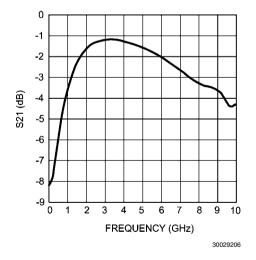


FIGURE 3. Typical Equalizer Transfer Function

5

TABLE 1. Typical Through Response

| Frequency (GHz) | DS38EP100 Attenuation Typ (dB) |
|-----------------|--------------------------------|
| 0.1 | -7.98 |
| 0.5 | -5.93 |
| 1 | -3.53 |
| 1.5 | -2.25 |
| 2 | -1.58 |
| 3 | -1.14 |
| 4 | -1.26 |
| 5 | -1.54 |
| 6 | -1.99 |
| 7 | -2.62 |
| 8 | -3.26 |
| 9 | -3.61 |
| 10 | -4.26 |

Block Diagram

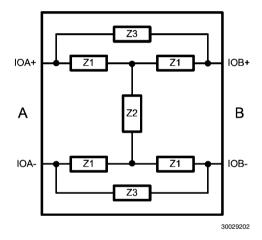


FIGURE 4. Simplified Block Diagram

Application Information

DS38EP100 DEVICE DESCRIPTION

The DS38EP100 Power-Saver equalizer is a passive network circuit composed of resistive, capacitive, and inductive components (See *Figure 4*). A differential bridged T-network compensates for the transmission medium losses and minimizes medium-induced deterministic jitter with FR4 and cables. The equalizer attenuates low frequency signals and is a bandpass filter at the resonant frequency. The response is linear and symmetric.

I/O TERMINATIONS

The DS38EP100 I/O impedance is 100Ω differential. The equalizer is designed for 100Ω -balanced differential signals and is not intended for single-ended transmission.

LINEAR COMPENSATION

The unique linear compensation feature of the DS38EP100 combined with the tiny package allows maximum flexibility in placement. The equalizer can be placed anywhere in the data

path and will provide the same compensation at the receiving circuit. (See Simplified Application Diagram)

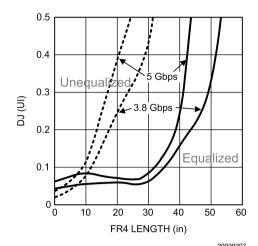
SYMMETRIC I/O STRUCTURES

The symmetry of the passive equalization network allows bidirectional operation. Signals receive equal compensation regardless of the direction of data flow. (See *Figure 4*).

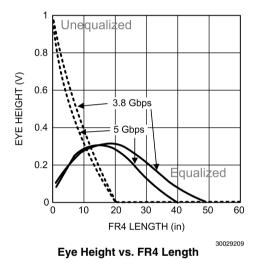
PCB LAYOUT CONSIDERATIONS FOR DIFFERENTIAL PAIRS AND NO CONNECT PADS

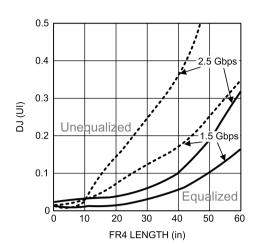
The differential I/Os must have a controlled differential impedance of 100Ω . It is preferable to route all differential lines exclusively on one layer of the board. The use of vias should be avoided if possible. If vias must be used, they should be used sparingly and must be placed symmetrically for each side of a given differential pair. Differential signals should be routed away from other signals and noise sources on the printed circuit board. Pin 2, Pin 5, and the center DAP have to be left as a no connect. Therefore, do not connect the landing pads of these pins to the power or ground plane. See AN-1187 for additional information on the LLP package.

Typical Performance Characteristics

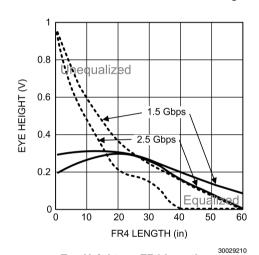


Residual Deterministic Jitter vs. FR4 Length





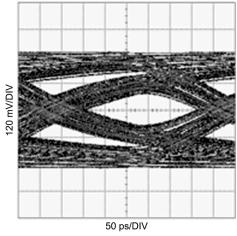
Residual Deterministic Jitter vs. FR4 Length



Eye Height vs. FR4 Length

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Typical Eye Diagrams — Includes Transmitter Setup, Interconnect, and Device Total Jitter



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FIGURE 5. Unequalized Signal (40in FR4, 2.5Gbps, PRBS7)

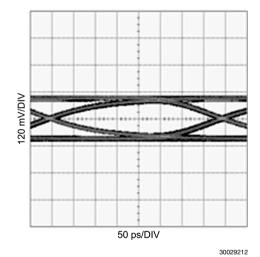
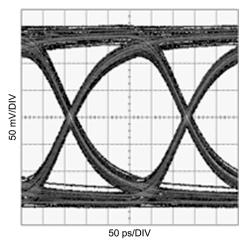
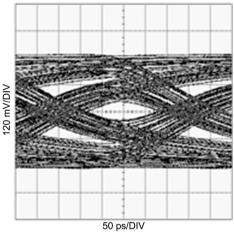


FIGURE 6. Equalized Signal (40in FR4, 2.5Gbps, PRBS7)



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FIGURE 7. Equalized Signal (Zoom) (40in FR4, 2.5Gbps, PRBS7)



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FIGURE 8. Unequalized Signal (40in FR4, 3.125Gbps, PRBS7)

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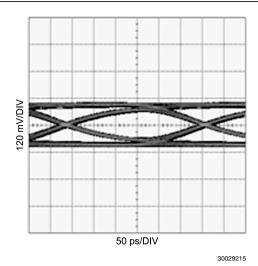


FIGURE 9. Equalized Signal (40in FR4, 3.125Gbps, PRBS7)

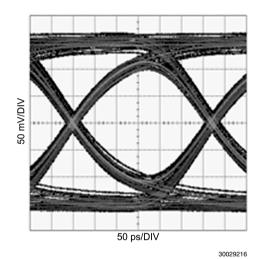


FIGURE 10. Equalized Signal (Zoom) (40in FR4, 3.125Gbps, PRBS7)

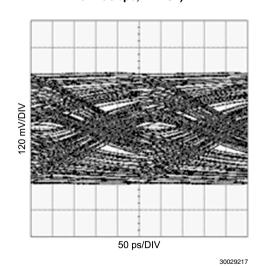
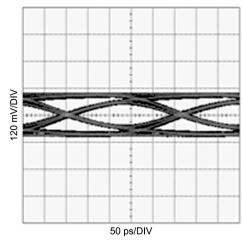
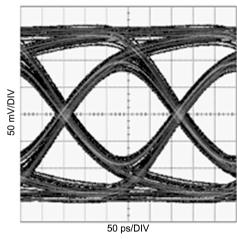


FIGURE 11. Unequalized Signal (40in FR4, 3.8Gbps, PRBS7)



30029218

FIGURE 12. Equalized Signal (40in FR4, 3.8Gbps, PRBS7)



30029219

FIGURE 13. Equalized Signal (Zoom) (40in FR4, 3.8Gbps, PRBS7)

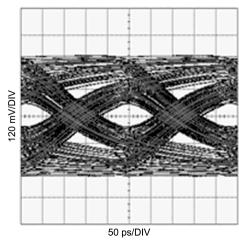


FIGURE 14. Unequalized Signal (30in FR4, 4.25Gbps, PRBS7)

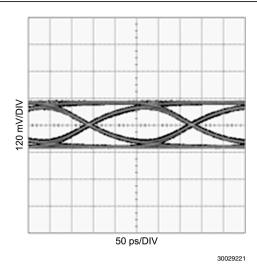


FIGURE 15. Equalized Signal (30in FR4, 4.25Gbps, PRBS7)

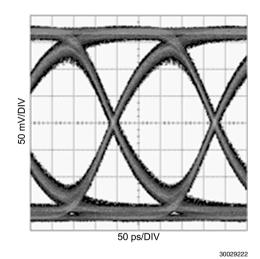


FIGURE 16. Equalized Signal (Zoom) (30in FR4, 4.25Gbps, PRBS7)

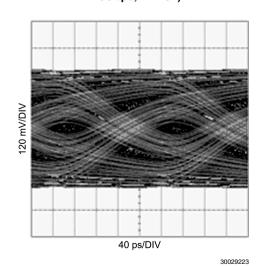


FIGURE 17. Unequalized Signal (30in FR4, 5Gbps, PRBS7)

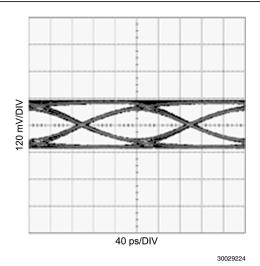


FIGURE 18. Equalized Signal (30in FR4, 5Gbps, PRBS7)

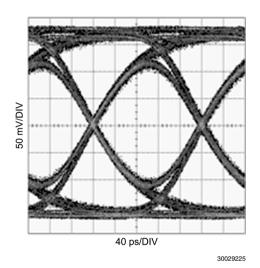
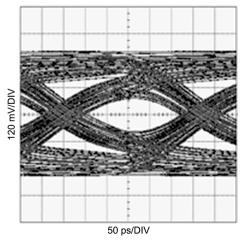


FIGURE 19. Equalized Signal (Zoom) (30in FR4, 5Gbps, PRBS7)



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FIGURE 20. Unequalized Signal (34in Tyco XAUI Backplane, 3.125Gbps, PRBS7)

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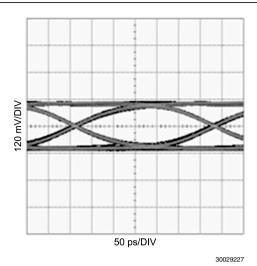


FIGURE 21. Equalized Signal (34in Tyco XAUI Backplane, 3.125Gbps, PRBS7)

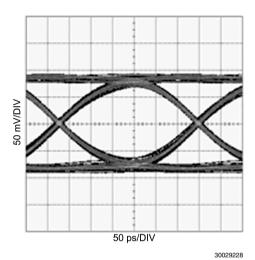


FIGURE 22. Equalized Signal (Zoom) (34in Tyco XAUI Backplane, 3.125Gbps, PRBS7)

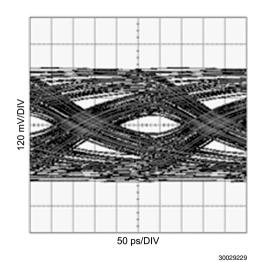
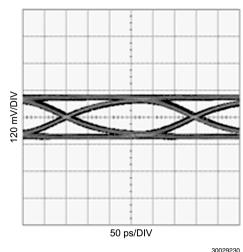
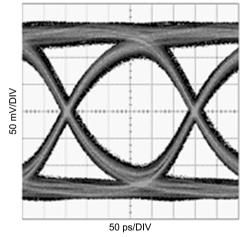


FIGURE 23. Unequalized Signal (5m 28AWG HDMI Cable, 3.4Gbps, PRBS7)



30029230

FIGURE 24. Equalized Signal (5m 28AWG HDMI Cable, 3.4Gbps, PRBS7)



30029231

FIGURE 25. Equalized Signal (Zoom) (5m 28AWG HDMI Cable, 3.4Gbps, PRBS7)

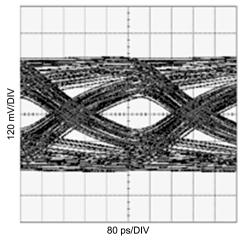


FIGURE 26. Unequalized Signal (10m 26AWG HDMI Cable, 2.25Gbps, PRBS7)

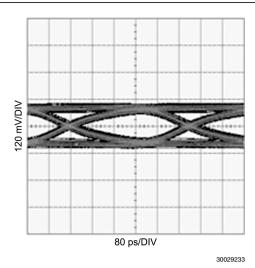


FIGURE 27. Equalized Signal (10m 26AWG HDMI Cable, 2.25Gbps, PRBS7)

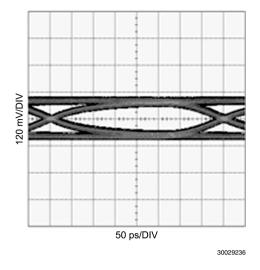


FIGURE 30. Equalized Signal (10m 24AWG PCIe Cable, 2.5Gbps, PRBS7)

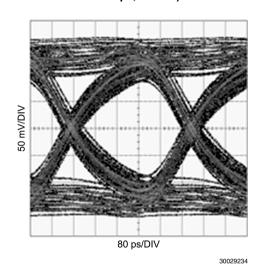


FIGURE 28. Equalized Signal (Zoom) (10m 26AWG HDMI Cable, 2.25Gbps, PRBS7)

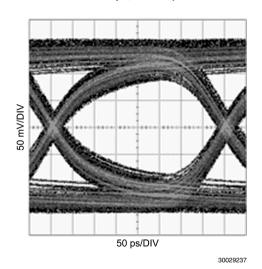


FIGURE 31. Equalized Signal (Zoom) (10m 24AWG PCle Cable, 2.5Gbps, PRBS7)

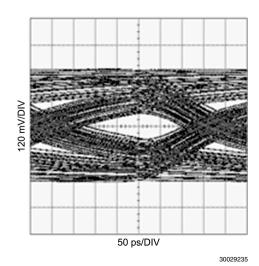


FIGURE 29. Unequalized Signal (10m 24AWG PCIe Cable, 2.5Gbps, PRBS7)

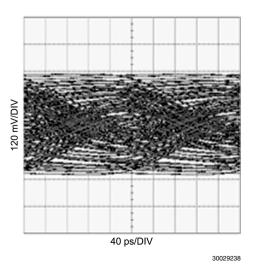
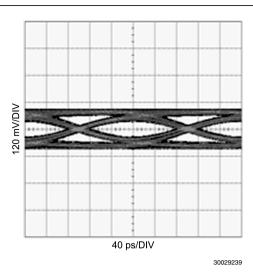


FIGURE 32. Unequalized Signal (10m 24AWG PCIe Cable, 5Gbps, PRBS7)



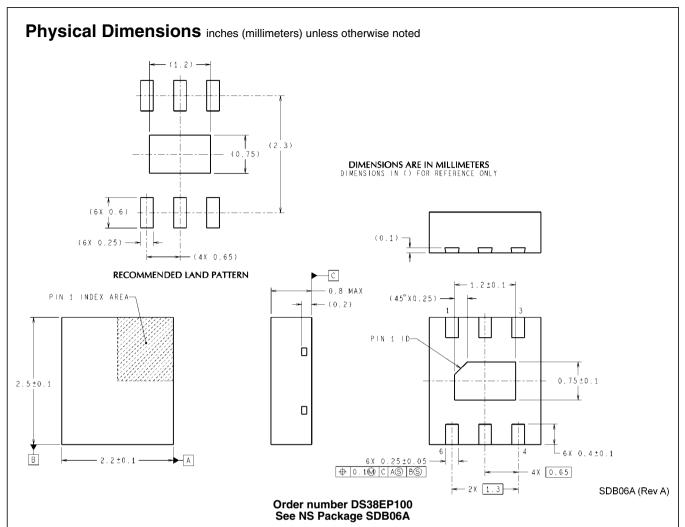
AIQ/NE 09

40 ps/DIV

30029240

FIGURE 33. Equalized Signal (10m 24AWG PCIe Cable, 5Gbps, PRBS7)

FIGURE 34. Equalized Signal (Zoom) (10m 24AWG PCle Cable, 5Gbps, PRBS7)



Notes

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